SDFS066A - MARCH 1987 - REVISED OCTOBER 1993

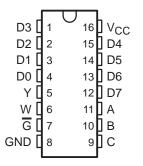
- 3-State Versions of SN54F151B and SN74F151B
- 3-State Outputs Interface Directly With System Bus
- Performs Parallel-to-Serial Conversion
- Complementary Outputs Provide True and Inverted Data
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

description

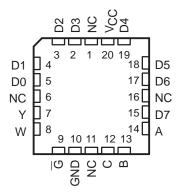
These data selectors/multiplexers contain full binary decoding to select one of eight data sources and feature strobe-controlled complementary outputs. The 3-state outputs can interface with and drive data lines of busorganized systems. When the strobe (\overline{G}) input is high, both outputs are in a high-impedance state in which both the upper and lower transistors of each totem-pole output are off, and the output neither drives nor loads the bus significantly.

The SN54F251B is characterized for operation over the full military temperature range of -55° C to 125°C. The SN74F251B is characterized for operation from 0°C to 70°C.

SN54F251B . . . J PACKAGE SN74F251B . . . D OR N PACKAGE (TOP VIEW)



SN54F251B . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

FUNCTION TABLE

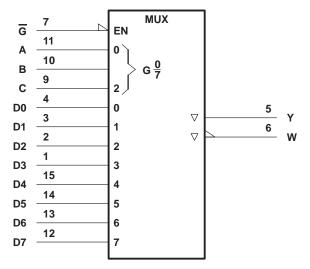
	IN	OUTPUTS					
	SELECT	•	STROBE	0017013			
С	В	Α	G	Υ	W		
Х	Х	X	Н	Z	Z		
L	L	L	L	D0	D0		
L	L	Н	L	D1	D1		
L	Н	L	L	D2	D2		
L	Н	Н	L	D3	D3		
Н	L	L	L	D4	D4		
Н	L	Н	L	D5	D5		
Н	Н	L	L	D6	D6		
Н	Н	Н	L	D7	D7		

D0, D1, . . . D7 = the level of the respective D input.



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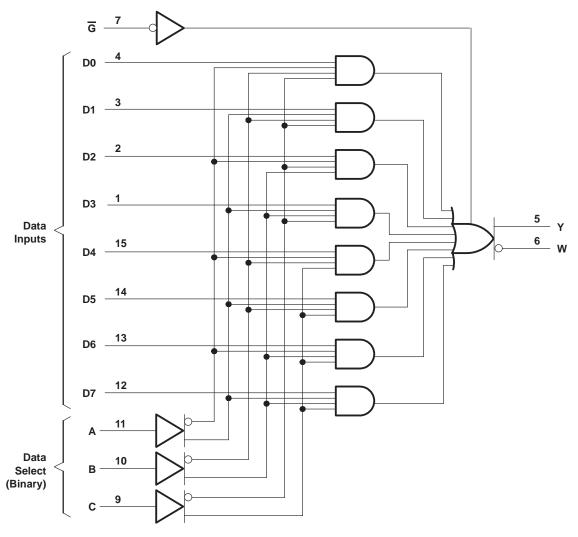
logic symbol†



 \dagger This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, and N packages.



logic diagram (positive logic)



Pin numbers shown are for the D, J, and N packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		0.5 V to 7 V
Input voltage range (see Note 1)		–1.2 V to 7 V
Input current range		–30 mA to 5 mA
Voltage range applied to any output in	the disabled or power-off state .	0.5 V to 5.5 V
Voltage range applied to any output in	the high state	0.5 V to V _{CC}
Current into any output in the low state	: SN54F251B	40 mA
		48 mA
Operating free-air temperature range:	SN54F251B	–55°C to 125°C
	SN74F251B	0°C to 70°C
Storage temperature range		−65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.



SN54F251B, SN74F251B 1-OF-8 DATA SELECTORS/MULTIPLEXERS **WITH 3-STATE OUTPUTS**

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recommended operating conditions

		SI	SN54F251B		SI	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2			2			V
V _{IL}	Low-level input voltage			0.8			0.8	V
liK	Input clamp current			-18			-18	mA
IOH	High-level output current			-3			-3	mA
loL	Low-level output current			20			24	mA
TA	Operating free-air temperature	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SI	N54F251	В	SI	N74F251	В	LINUT
PARAMETER	TEST C	UNDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
VIK	$V_{CC} = 4.5 \text{ V},$	$I_{I} = -18 \text{ mA}$			-1.2			-1.2	V
	V _{CC} = 4.5 V	$I_{OH} = -1 \text{ mA}$	2.5	3.4		2.5	3.4		
Voн	VCC = 4.5 V	$I_{OH} = -3 \text{ mA}$	2.4	3.3		2.4	3.3		V
	$V_{CC} = 4.75 \text{ V},$	$I_{OH} = -1 \text{ mA to } -3 \text{ mA}$				2.7			
V/0:	V _{CC} = 4.5 V	$I_{OL} = 20 \text{ mA}$		0.3	0.5				V
VOL	VCC = 4.5 V	$I_{OL} = 24 \text{ mA}$				0.35		0.5	V
lozh	$V_{CC} = 5.5 \text{ V},$	$V_0 = 2.7 \text{ V}$			50			50	μΑ
lozL	$V_{CC} = 5.5 \text{ V},$	$V_0 = 0.5 V$			-50			-50	μΑ
lį	$V_{CC} = 5.5 \text{ V},$	V _I = 7 V			0.1			0.1	mA
lіН	$V_{CC} = 5.5 \text{ V},$	$V_{I} = 2.7 \text{ V}$			20			20	μΑ
I _{IL}	$V_{CC} = 5.5 \text{ V},$	V _I = 0.5 V			- 0.6			- 0.6	mA
los [‡]	V _{CC} = 5.5 V,	V _O = 0	-60		-150	-60		-150	mA
laa	V _{CC} = 5.5 V,	Condition A		15	22		15	22	mA
lcc	See Note 2	Condition B		16	24		16	24	IIIA

[†] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



[‡] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTE 2: I_{CC} is measured with the outputs open under the following conditions:

A. Select input and data input at 4.5 V, output control grounded

B. All inputs at 4.5 V

switching characteristics (see Note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _l R ² R:	CC = 5 V L = 50 p 1 = 500 s 2 = 500 s 4 = 25°C	F, Ω, Ω,	C R R	L = 50 p 1 = 500 s 2 = 500 s	Ω,		UNIT
				′F251B		SN54F251B		SN74F251B		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	A, B, or C	W	3.5	5.4	9	3.5	11.5	3.5	9.5	ns
tPHL	A, B, 01 C	VV	2.5	4.4	7.5	2.5	8	2.5	7.5	113
^t PLH	A, B, or C	Y	4.5	6.2	10.5	3.5	14	4	12.5	ns
t _{PHL}	A, B, Of C	ı	4	6	8.5	3	10.9	3.5	9	115
t _{PLH}	Any D	W	2.5	3.7	6.5	1.8	8	2	7	ns
^t PHL	Ally D	VV	1	1.9	4	1	6	1	5	115
^t PLH	Any D	Y	3	3.8	7	2.3	9	2.3	8	ns
^t PHL	Ally D	'	3	4.5	7	2.3	9	2.5	8] "
^t PZH	G	W	2.5	3.6	6	2	7	2	7	ns
t _{PZL}	G	VV	2.5	3.8	6	2.5	7.5	2.5	6.5	115
^t PHZ	G	W	1.9	2.5	5.5	1.4	6	1.5	6	
t _{PLZ}	G	VV	1	2.4	4.5	1	5	1	4.5	ns
^t PZH	G	Y	3.4	4.8	7	2.7	8.5	2.9	8.5	ns
t _{PZL}			2.9	4	7.5	2.6	9	2.6	8	1115
^t PHZ	G	Y	1.9	2.5	5.5	1.7	5.5	1.8	5.5	
t _{PLZ}			1	2.3	4.5	1	5.5	1	4.5	ns

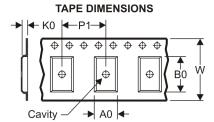
[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 3: Load circuits and waveforms are shown in Section 1.





TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device		Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74F251BDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1





*All dimensions are nominal

Ī	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
	SN74F251BDR	SOIC	D	16	2500	333.2	345.9	28.6

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